### 查询AT24C256BY1-10YU-1.8供应商

## 捷多邦,专业PCB打样工厂,24小时加急出货

## Features

- Low-voltage and Standard-voltage Operation
- 1.8 (V<sub>CC</sub> = 1.8V to 3.6V)
- Internally Organized as 32,768 x 8
- Two-wire Serial Interface
- Schmitt Trigger, Filtered Inputs for Noise Suppression
- Bidirectional Data Transfer Protocol
- 1 MHz (3.6V, 2.7V, 2.5V), and 400 kHz (1.8V) Compatibility
- Write Protect Pin for Hardware and Software Data Protection
- 64-byte Page Write Mode (Partial Page Writes Allowed)
- Self-timed Write Cycle (5 ms Max)
- High Reliability
  - Endurance: One Million Write Cycles
  - Data Retention: 40 Years
- Extended Temperature and Lead-free/Halogen-free Devices Available
- 8-lead JEDEC PDIP, 8-lead JEDEC SOIC, 8-lead MAP, 8-lead TSSOP, and 8-ball dBGA2<sup>™</sup> Packages

# Description

The AT24C256B provides 262,144 bits of serial electrically erasable and programmable read-only memory (EEPROM) organized as 32,768 words of 8 bits each. The device's cascadable feature allows up to eight devices to share a common two-wire bus. The device is optimized for use in many industrial and commercial applications where low-power and low-voltage operation are essential. The devices are available in space-saving 8-lead JEDEC PDIP, 8-lead JEDEC SOIC, 8-lead MAP, 8-lead TSSOP, and 8-ball dBGA2 packages. In addition, the entire family is available in a 1.8V (1.8V to 3.6V) version.

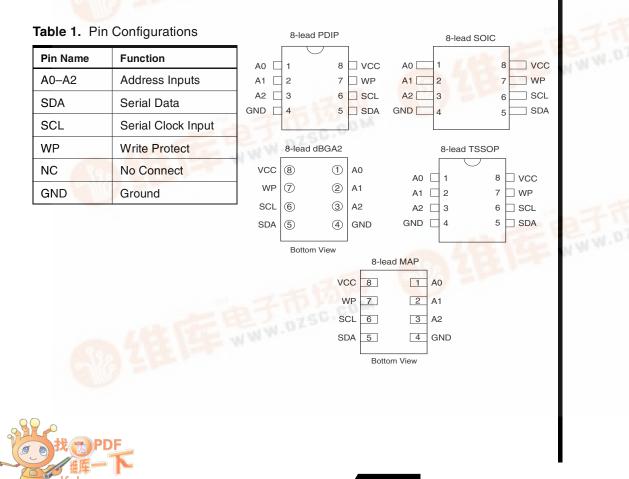


# Two-wire Serial EEPROM

256K (32,768 x 8)

# AT24C256B

# Preliminary

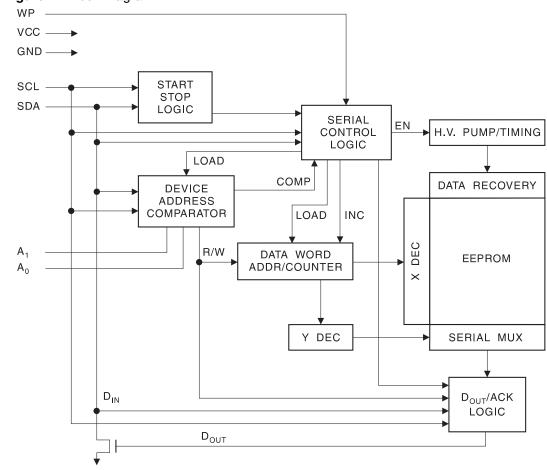




# **Absolute Maximum Ratings\***

Operating Temperature55°C to +125°C
Storage Temperature65°C to +150°C
Voltage on Any Pin with Respect to Ground1.0V to +5.0V
Maximum Operating Voltage 4.3V
DC Output Current 5.0 mA

\*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



# Figure 1. Block Diagram

# 2 AT24C256B

**Pin Description** SERIAL CLOCK (SCL): The SCL input is used to positive-edge clock data into each EEPROM device and negative-edge clock data out of each device.

**SERIAL DATA (SDA):** The SDA pin is bidirectional for serial data transfer. This pin is opendrain driven and may be wire-ORed with any number of other open-drain or open-collector devices.

**DEVICE/PAGE ADDRESSES (A2, A1, A0):** The A2, A1, and A0 pins are device address inputs that are hardwired (directly to GND or to Vcc) for compatibility with other AT24Cxx devices. When the pins are hardwired, as many as eight 256K devices may be addressed on a single bus system. (Device addressing is discussed in detail under "Device Addressing," page 8.) A device is selected when a corresponding hardware and software match is true. If these pins are left floating, the A2, A1, and A0 pins will be internally pulled down to GND. However, due to capacitive coupling that may appear during customer applications, Atmel recommends always connecting the address pins to a known state. When using a pull-up resistor, Atmel recommends using  $10k\Omega$  or less.

**WRITE PROTECT (WP):** The write protect input, when connected to GND, allows normal write operations. When WP is connected directly to Vcc, all write operations to the memory are inhibited. If the pin is left floating, the WP pin will be internally pulled down to GND. However, due to capacitive coupling that may appear during customer applications, Atmel recommends always connecting the WP pins to a known state. When using a pull-up resistor, Atmel recommends using  $10k\Omega$  or less.

Memory Organization **AT24C256B**, **256K SERIAL EEPROM:** The 256K is internally organized as 512 pages of 64 bytes each. Random word addressing requires a 15-bit data word address.





## Table 1. Pin Capacitance<sup>(1)</sup>

Applicable over recommended operating range from  $T_A = 25^{\circ}C$ , f = 1.0 MHz,  $V_{CC} = +1.8V$ 

Symbol	Test Condition	Max	Units	Conditions
C <sub>I/O</sub>	Input/Output Capacitance (SDA)	8	pF	$V_{I/O} = 0V$
C <sub>IN</sub>	Input Capacitance (A <sub>0</sub> , A <sub>1</sub> , SCL)	6	pF	$V_{IN} = 0V$

Note: 1. This parameter is characterized and is not 100% tested.

### Table 2. DC Characteristics

Applicable over recommended operating range from:  $T_{AI} = -40^{\circ}C$  to  $+85^{\circ}C$ ,  $V_{CC} = +1.8V$  to +3.6V (unless otherwise noted)

Symbol	Parameter	Test Condition		Min	Тур	Max	Units
V <sub>CC1</sub>	Supply Voltage			1.8		3.6	V
I <sub>CC1</sub>	Supply Current	$V_{\rm CC} = 3.6 V$	READ at 400 kHz		1.0	2.0	mA
I <sub>CC2</sub>	Supply Current	V <sub>CC</sub> = 3.6V	WRITE at 400 kHz		2.0	3.0	mA
	Standby Current (1.8V option)	V <sub>CC</sub> = 1.8V				1.0	μA
I <sub>SB1</sub>		V <sub>CC</sub> = 3.6V	$V_{\rm IN} = V_{\rm CC} \text{ or } V_{\rm SS}$			3.0	
ILI	Input Leakage Current	$V_{IN} = V_{CC} \text{ or } V_{SS}$			0.10	3.0	μA
I <sub>LO</sub>	Output Leakage Current	$V_{OUT} = V_{CC} \text{ or } V$	SS		0.05	3.0	μA
V <sub>IL</sub>	Input Low Level <sup>(1)</sup>			-0.6		V <sub>CC</sub> x 0.3	V
V <sub>IH</sub>	Input High Level <sup>(1)</sup>			V <sub>CC</sub> x 0.7		V <sub>CC</sub> + 0.5	V
V <sub>OL2</sub>	Output Low Level	V <sub>CC</sub> = 3.0V	I <sub>OL</sub> = 2.1 mA			0.4	V
V <sub>OL1</sub>	Output Low Level	V <sub>CC</sub> = 1.8V	l <sub>OL</sub> = 0.15 mA			0.2	V

Notes: 1.  $V_{\rm IL}$  min and  $V_{\rm IH}$  max are reference only and are not tested.

**Table 3.** AC Characteristics (Industrial Temperature)

Applicable over recommended operating range from  $T_{AI} = -40^{\circ}C$  to  $+85^{\circ}C$ ,  $V_{CC} = +1.8V$  to +3.6V, CL = 100 pF (unless otherwise noted). Test conditions are listed in Note 2.

		1.8-volt		2.5-volt		3.6-volt		
Symbol	Parameter		Max	Min	Мах	Min	Max	Units
f <sub>SCL</sub>	Clock Frequency, SCL		400		1000		1000	kHz
t <sub>LOW</sub>	Clock Pulse Width Low	1.3		0.4		0.4		μs
t <sub>HIGH</sub>	Clock Pulse Width High	0.6		0.4		0.4		μs
t <sub>AA</sub>	Clock Low to Data Out Valid	0.05	0.9	0.05	0.55	0.05	0.55	μs
t <sub>BUF</sub>	Time the bus must be free before a new transmission can start <sup>(1)</sup>	1.3		0.5		0.5		μs
t <sub>HD.STA</sub>	Start Hold Time	0.6		0.25		0.25		μs
t <sub>SU.STA</sub>	Start Set-up Time	0.6		0.25		0.25		μs
t <sub>HD.DAT</sub>	Data In Hold Time	0		0		0		μs
t <sub>SU.DAT</sub>	Data In Set-up Time	100		100		100		ns
t <sub>R</sub>	Inputs Rise Time <sup>(1)</sup>		0.3		0.3		0.3	μs
t <sub>F</sub>	Inputs Fall Time <sup>(1)</sup>		300		100		100	ns
t <sub>SU.STO</sub>	Stop Set-up Time	0.6		0.25		0.25		μs
t <sub>DH</sub>	Data Out Hold Time	50		50		50		ns
t <sub>WR</sub>	Write Cycle Time		5		5		5	ms
Endurance <sup>(1)</sup>	25°C, Page Mode, 3.3V	1,000,000				Write Cycles		

Notes: 1. This parameter is characterized and is not 100% tested.

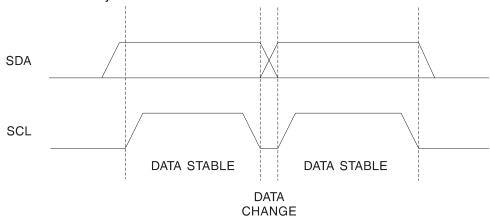
2. AC measurement conditions:  $R_L$  (connects to V<sub>CC</sub>): 1.3 k $\Omega$  (2.5V, 3.6V), 10 k $\Omega$  (1.8V) Input pulse voltages: 0.3 V<sub>CC</sub> to 0.7 V<sub>CC</sub> Input rise and fall times:  $\leq$  50 ns Input and output timing reference voltages: 0.5 V<sub>CC</sub>



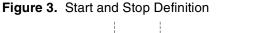


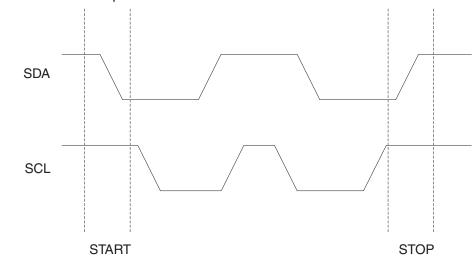
Device **CLOCK and DATA TRANSITIONS:** The SDA pin is normally pulled high with an external device. Data on the SDA pin may change only during SCL low time periods (see Figure 2). Operation Data changes during SCL high periods will indicate a start or stop condition as defined below.





START CONDITION: A high-to-low transition of SDA with SCL high is a start condition that must precede any other command (see Figure 3).





STOP CONDITION: A low-to-high transition of SDA with SCL high is a stop condition. After a read sequence, the stop command will place the EEPROM in a standby power mode (see Figure 3).

ACKNOWLEDGE: All addresses and data words are serially transmitted to and from the EEPROM in 8-bit words. The EEPROM sends a "0" during the ninth clock cycle to acknowledge that it has received each word.

STANDBY MODE: The AT24C256B features a low-power standby mode that is enabled upon power-up and after the receipt of the stop bit and the completion of any internal operations.

6

**MEMORY RESET:** After an interruption in protocol, power loss or system reset, any two-wire part can be reset by following these steps:

- 1. Clock up to 9 cycles;
- 2. Look for SDA high in each cycle while SCL is high;
- 3. Create a start condition as SDA is high.

### Figure 4. Bus Timing

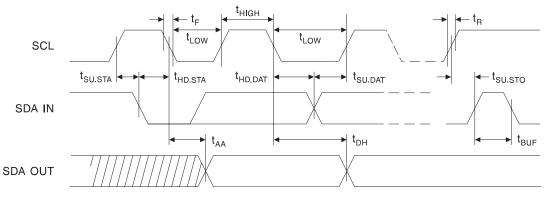
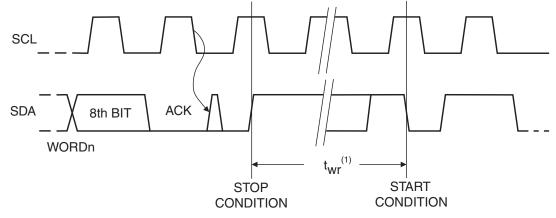


Figure 5. Write Cycle Timing

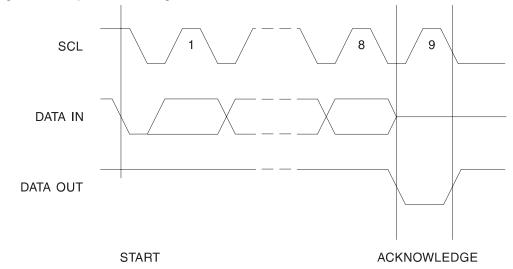


Note: 1. The write cycle time t<sub>WR</sub> is the time from a valid stop condition of a write sequence to the end of the internal clear/write cycle.





### Figure 6. Output Acknowledge



## Device Addressing

The 256K EEPROM requires an 8-bit device address word following a start condition to enable the chip for a read or write operation (see Figure 7). The device address word consists of a mandatory "1", "0" sequence for the first four most significant bits as shown. This is common to all two-wire EEPROM devices.

Figure 7. Device Address

1	0	1	0	A2	A1	A0	R/W
MSB							LSB

The next three bits are the A2, A1, A0 device address bits to allow as many as eight devices on the same bus. These bits must compare to their corresponding hardwired input pins. The A2, A1, and A0 pins use an internal proprietary circuit that biases them to a logic low condition if the pins are allowed to float.

The eighth bit of the device address is the read/write operation select bit. A read operation is initiated if this bit is high, and a write operation is initiated if this bit is low.

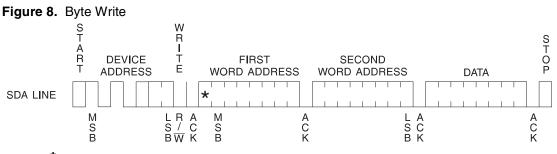
Upon a compare of the device address, the EEPROM will output a "0". If a compare is not made, the device will return to a standby state.

**DATA SECURITY:** The AT24C256B has a hardware data protection scheme that allows the user to write protect the whole memory when the WP pin is at  $V_{CC}$ .

8

# Write Operations

**BYTE WRITE:** A write operation requires two 8-bit data word addresses following the device address word and acknowledgment. Upon receipt of this address, the EEPROM will again respond with a "0" and then clock in the first 8-bit data word. Following receipt of the 8-bit data word, the EEPROM will output a "0". The addressing device, such as a microcontroller, must then terminate the write sequence with a stop condition. At this time the EEPROM enters an internally-timed write cycle, t<sub>WR</sub>, to the nonvolatile memory. All inputs are disabled during this write cycle and the EEPROM will not respond until the write is complete (see Figure 8).

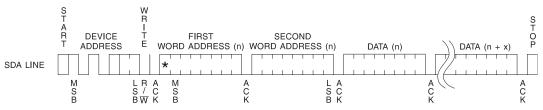


Note: **\*** = DON'T CARE bit



A page write is initiated the same way as a byte write, but the microcontroller does not send a stop condition after the first data word is clocked in. Instead, after the EEPROM acknowledges receipt of the first data word, the microcontroller can transmit up to 63 more data words. The EEPROM will respond with a "0" after each data word received. The microcontroller must terminate the page write sequence with a stop condition (see Figure 9).





Note: **\*** = DON'T CARE bit

The data word address lower six bits are internally incremented following the receipt of each data word. The higher data word address bits are not incremented, retaining the memory page row location. When the word address, internally generated, reaches the page boundary, the following byte is placed at the beginning of the same page. If more than 64 data words are transmitted to the EEPROM, the data word address will "roll over" and previous data will be overwritten. The address "roll over" during write is from the last byte of the current page to the first byte of the same page.

**ACKNOWLEDGE POLLING:** Once the internally-timed write cycle has started and the EEPROM inputs are disabled, acknowledge polling can be initiated. This involves sending a start condition followed by the device address word. The read/write bit is representative of the operation desired. Only if the internal write cycle has completed will the EEPROM respond with a "0", allowing the read or write sequence to continue.



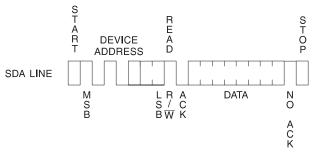
# Read Operations

Read operations are initiated the same way as write operations with the exception that the read/write select bit in the device address word is set to "1". There are three read operations: current address read, random address read, and sequential read.

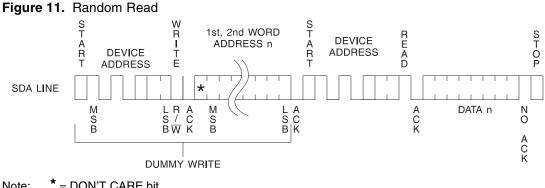
CURRENT ADDRESS READ: The internal data word address counter maintains the last address accessed during the last read or write operation, incremented by one. This address stays valid between operations as long as the chip power is maintained. The address "roll over" during read is from the last byte of the last memory page, to the first byte of the first page.

Once the device address with the read/write select bit set to "1" is clocked in and acknowledged by the EEPROM, the current address data word is serially clocked out. The microcontroller does not respond with an input "0" but does generate a following stop condition (see Figure 10).

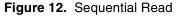
### Figure 10. Current Address Read

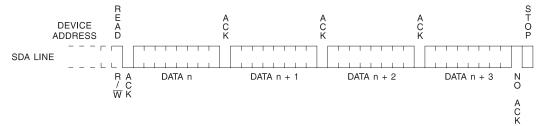


RANDOM READ: A random read requires a "dummy" byte write sequence to load in the data word address. Once the device address word and data word address are clocked in and acknowledged by the EEPROM, the microcontroller must generate another start condition. The microcontroller now initiates a current address read by sending a device address with the read/write select bit high. The EEPROM acknowledges the device address and serially clocks out the data word. The microcontroller does not respond with a "0" but does generate a following stop condition (see Figure 11).



**SEQUENTIAL READ:** Sequential reads are initiated by either a current address read or a random address read. After the microcontroller receives a data word, it responds with an acknowledge. As long as the EEPROM receives an acknowledge, it will continue to increment the data word address and serially clock out sequential data words. When the memory address limit is reached, the data word address will "roll over" and the sequential read will continue. The sequential read operation is terminated when the microcontroller does not respond with a "0" but does generate a following stop condition (see Figure 12).









# AT24C256B Ordering Information

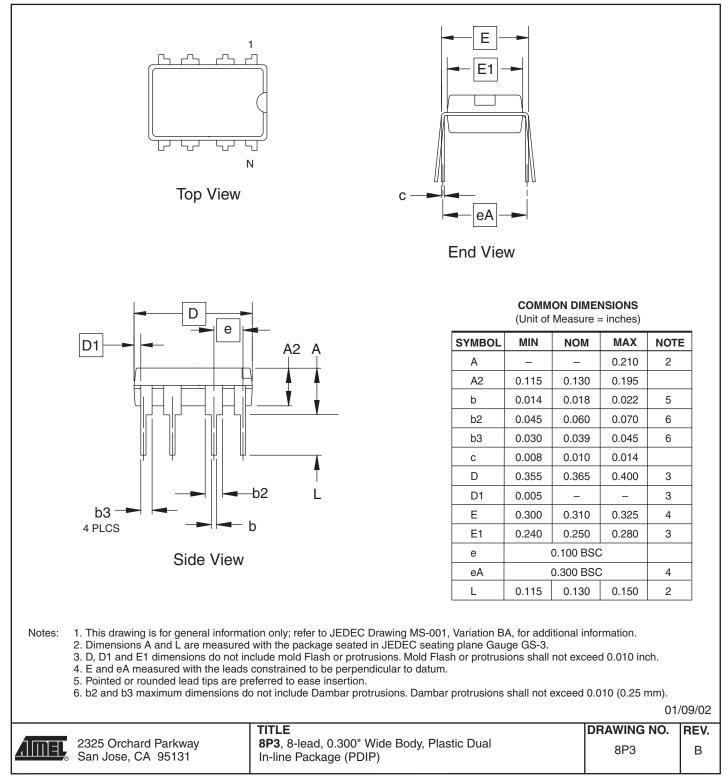
Ordering Code	Package	Operation Range
AT24C256B-10PU-1.8	8P3	
AT24C256BN-10SU-1.8	8S1	Lead-free/Halogen-free
AT24C256BU2-10UU-1.8	8U2-1	Industrial Temperature
AT24C256B-10TU-1.8	8A2	(-40°C to 85°C
AT24C256BY1-10YU-1.8	8Y1	

Package Type							
8P3	8P3 8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)						
8S1	8S1 8-lead, 0.150" Wide, Plastic Gull Wing Small Outline Package (JEDEC SOIC)						
8U2-1	BU2-1 8-ball, die Ball Grid Array Package (dBGA2)						
8A2	8A2 8-lead, 0.170" Wide, Thin Shrink Small Outline Package (TSSOP)						
8Y1 8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leaded, Miniature Array Package (MAP)							
	Options						
-1.8	-1.8 Low-voltage (1.8V to 3.6V)						

# 12 AT24C256B

# **Packaging Information**

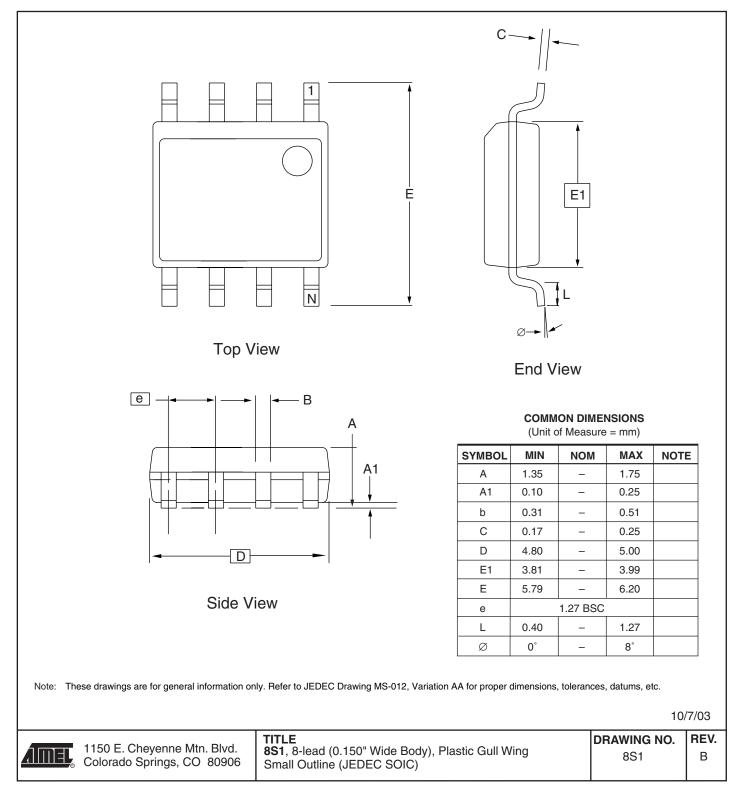
## 8P3 – PDIP





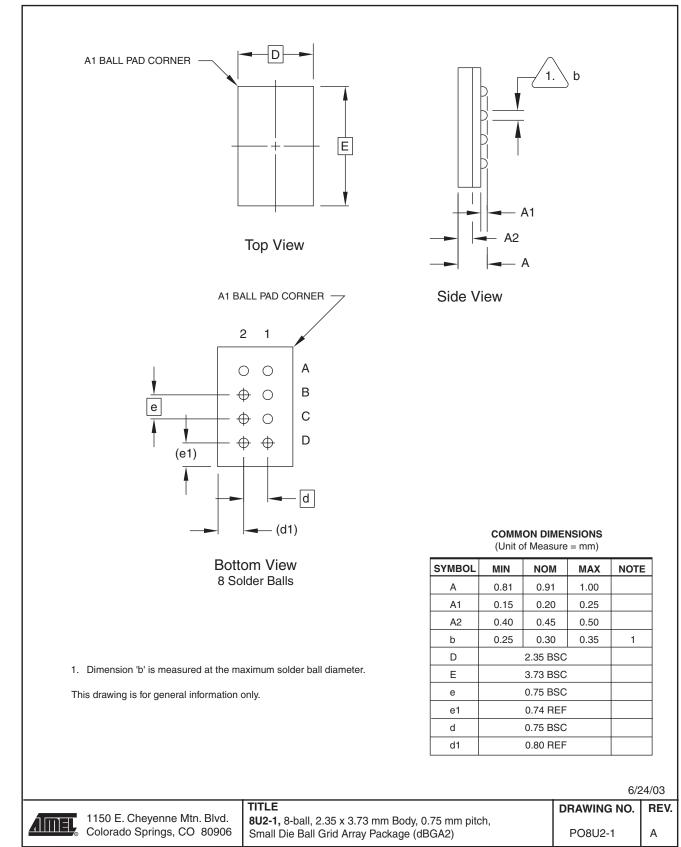


## 8S1 – JEDEC SOIC



# 14 AT24C256B

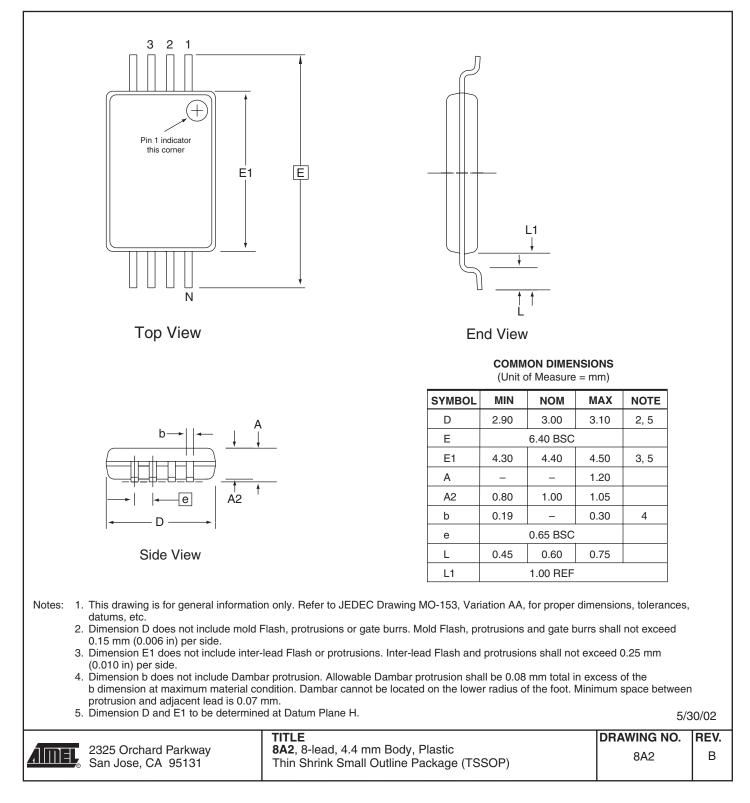
## 8U2-1 - dBGA2



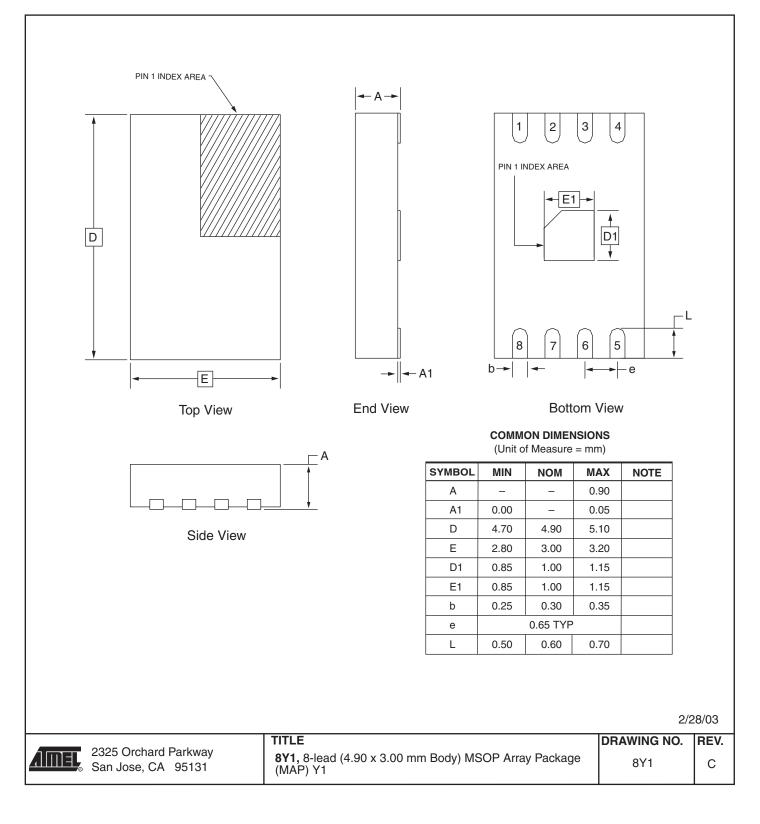




## 8A2 – TSSOP



8Y1 – MAP







## **Atmel Corporation**

2325 Orchard Parkway San Jose, CA 95131, USA Tel: 1(408) 441-0311 Fax: 1(408) 487-2600

### **Regional Headquarters**

#### Europe

Atmel Sarl Route des Arsenaux 41 Case Postale 80 CH-1705 Fribourg Switzerland Tel: (41) 26-426-5555 Fax: (41) 26-426-5500

### Asia

Room 1219 Chinachem Golden Plaza 77 Mody Road Tsimshatsui East Kowloon Hong Kong Tel: (852) 2721-9778 Fax: (852) 2722-1369

### Japan

9F, Tonetsu Shinkawa Bldg. 1-24-8 Shinkawa Chuo-ku, Tokyo 104-0033 Japan Tel: (81) 3-3523-3551 Fax: (81) 3-3523-7581

### **Atmel Operations**

*Memory* 2325 Orchard Parkway San Jose, CA 95131, USA Tel: 1(408) 441-0311 Fax: 1(408) 436-4314

*Microcontrollers* 2325 Orchard Parkway San Jose, CA 95131, USA Tel: 1(408) 441-0311 Fax: 1(408) 436-4314

La Chantrerie BP 70602 44306 Nantes Cedex 3, France Tel: (33) 2-40-18-18-18 Fax: (33) 2-40-18-19-60

### ASIC/ASSP/Smart Cards

Zone Industrielle 13106 Rousset Cedex, France Tel: (33) 4-42-53-60-00 Fax: (33) 4-42-53-60-01

1150 East Cheyenne Mtn. Blvd. Colorado Springs, CO 80906, USA Tel: 1(719) 576-3300 Fax: 1(719) 540-1759

Scottish Enterprise Technology Park Maxwell Building East Kilbride G75 0QR, Scotland Tel: (44) 1355-803-000 Fax: (44) 1355-242-743 RF/Automotive Theresienstrasse 2 Postfach 3535 74025 Heilbronn, Germany Tel: (49) 71-31-67-0 Fax: (49) 71-31-67-2340

1150 East Cheyenne Mtn. Blvd. Colorado Springs, CO 80906, USA Tel: 1(719) 576-3300 Fax: 1(719) 540-1759

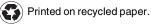
### Biometrics/Imaging/Hi-Rel MPU/

High Speed Converters/RF Datacom Avenue de Rochepleine BP 123 38521 Saint-Egreve Cedex, France Tel: (33) 4-76-58-30-00 Fax: (33) 4-76-58-34-80

*Literature Requests* www.atmel.com/literature

**Disclaimer:** Atmel Corporation makes no warranty for the use of its products, other than those expressly contained in the Company's standard warranty which is detailed in Atmel's Terms and Conditions located on the Company's web site. The Company assumes no responsibility for any errors which may appear in this document, reserves the right to change devices or specifications detailed herein at any time without notice, and does not make any commitment to update the information contained herein. No licenses to patents or other intellectual property of Atmel are granted by the Company in connection with the sale of Atmel products, expressly or by implication. Atmel's products are not authorized for use as critical components in life support devices or systems.

© Atmel Corporation 2004. All rights reserved. Atmel<sup>®</sup>, logo and combinations thereof are registered trademarks, and Everywhere You Are<sup>SM</sup> and dBGA2<sup>™</sup> are trademarks of Atmel Corporation or its subsidiaries. Other terms and product names may be the trademarks of others.



080A-SEEPR-9/04